

Features

- Low power loss, high efficiency
- Low profile - typical height of 0.65 mm
- Moisture sensitivity: level 1, per J-STD-020
- High temperature soldering guaranteed: 260°C/10 seconds
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications



SOD-323HE

Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Values	Unit
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	200	V
Maximum RMS Voltage	V_{RMS}	140	V
Maximum DC Blocking Voltage	V_{DC}	200	V
Maximum Average Forward Rectified Current	$I_{F(AV)}$	0.5	A
Peak Forward Surge Current 8.3ms Single Half Sine-wave Superimposed on Rated Load	I_{FSM}	15	A
Operating Junction Temperature Range	T_J	-55 To +175	°C
Storage Temperature Range	T_{STG}	-55 To +175	°C

Electrical Characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Test Conditions	Symbol	Values	Unit
Maximum Instantaneous Forward Voltage	$I_F=0.5\text{A}$	V_F	0.95	V
Maximum DC Reverse Current at Rated DC Blocking Voltage	$T_A=25^\circ\text{C}$	I_R	0.2	mA
	$T_A=100^\circ\text{C}$		15	
Typical Junction Capacitance	4.0V, 1 MHz	C_J	40	pF
Typical Thermal Resistance ¹	Junction to Ambient	$R_{\theta JA}$	150	°C/W
	Junction to Lead	$R_{\theta JL}$	10	

Note:

1. The thermal resistance from Junction to Ambient or Junction to Lead, mounted on P.C.B with 4x4mm copper pads, 2 OZ, FR4 PCB

Ratings and Characteristics Curves ($T_A=25^\circ\text{C}$ unless otherwise noted)

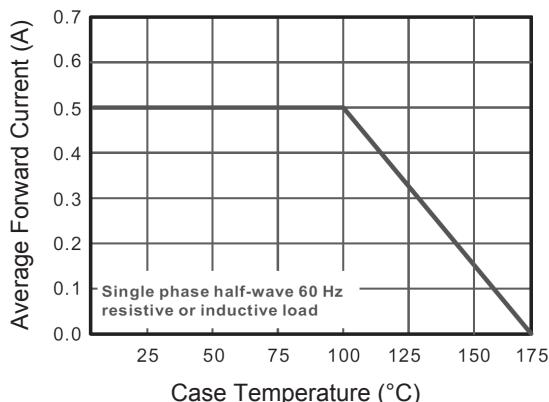


Figure 1. Forward Current Derating Curve

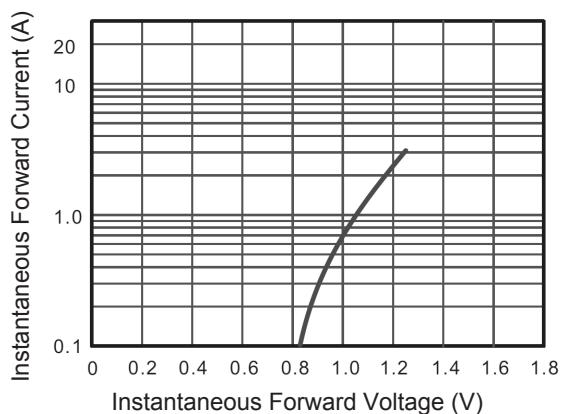


Figure 2. Typical Instantaneous Forward Characteristics

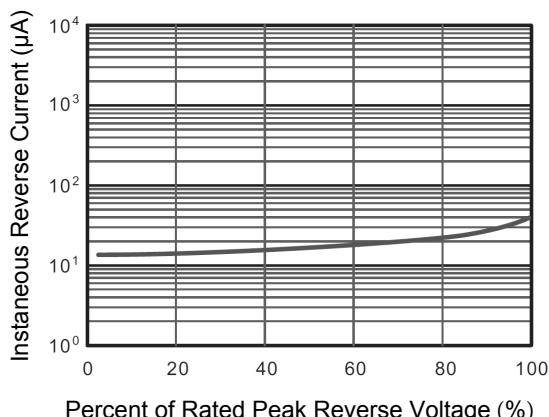


Figure 3. Typical Reverse Characteristics

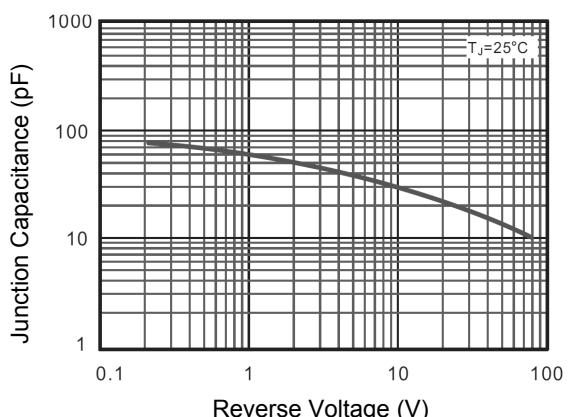


Figure 4. Typical Junction Capacitance

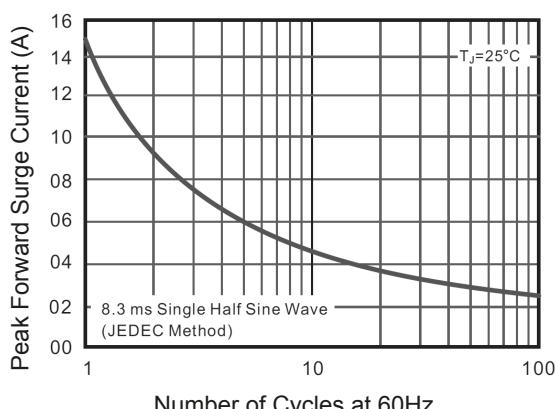


Figure 5. Maximum Non-Repetitive Peak Forward Surge Current

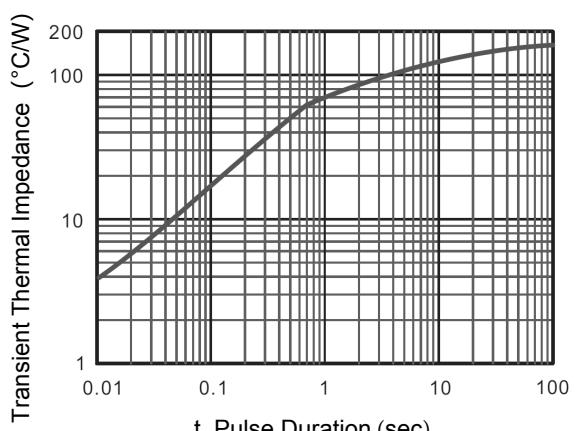
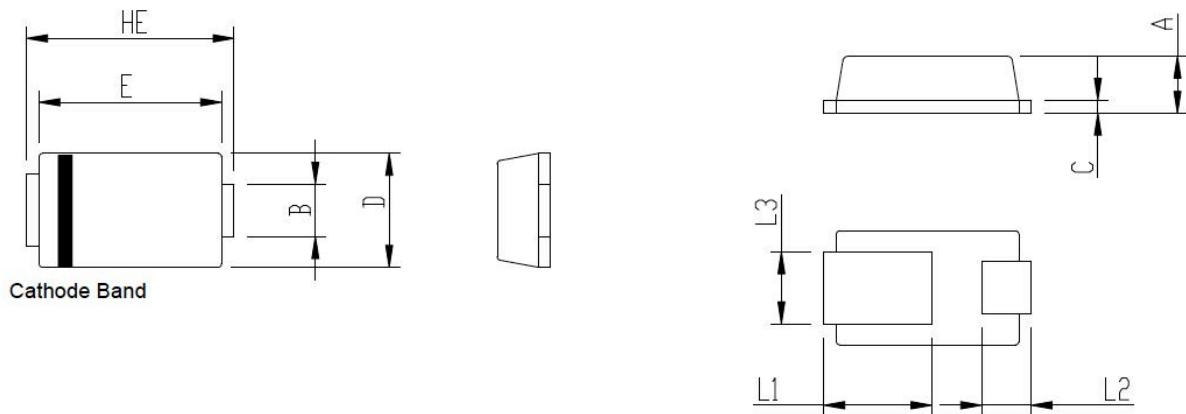


Figure 6. Typical Transient Thermal Impedance

Package Outline Dimensions (SOD-323HE)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.550	0.750	0.022	0.030
B	0.450	0.750	0.018	0.030
C	0.100	0.250	0.004	0.010
D	1.250	1.450	0.049	0.057
E	2.100	2.300	0.083	0.091
HE	2.300	2.700	0.091	0.106
L1	1.100	1.550	0.043	0.061
L2	0.250	0.500	0.010	0.020
L3	0.650	0.950	0.026	0.037

Recommended Pad Layout

